

TYS -Low Profile SMT Power Inductor

YS252010L Series

FEATURES AND APPLICATIONS

Laird TYS series high current power inductors improve performance, reliability and power efficiency. A lower profile benefits consumer electronics, industrial and telecom design. Products feature extremely low DCR with greater efficiency and enable a large current in a small size. Inductors are of magnetic shielding and wire wound construction and perform in operating temperatures ranging from -40 C to 125 C including self-heating rise in temperature.

FEATURES

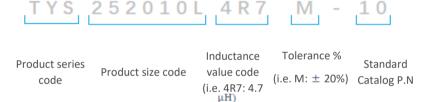
- Magnetic shielded structure
- · Low DCR and high efficiency
- Low profile and small size
- Ferrite core with high saturation

APPLICATIONS

- DC-DC Converter and Power Suppliers
- LCD TV'S and Gaming Console
- Tablet, Notebooks, Servers and Printers
- Networking and Data storage
- GPS, Set-top-box and Base stations
- Smart meters and Medical instruments



PART NUMBER EXPLANATION



ELECTRICAL SPECIFICATIONS

- Tolerance: M: ±20% or N: ±30%
- Inductance tested at 100kHz, 1.0Vrms
- Heat Rated Current (Irms) is defined based on temperature rise approximate 40°C (ambient temperature 25±5°C)
- Saturation Current (Isat) is the DC current at which the inductance drops off approximately 30% from its value without current. (ambient temperature 25±5°C)
- Operating temperature range: -40°C~+125°C (including self-heating temperature rise)
- Storage temperature range (packaging conditions): -10°C~+40°C and RH 70%(MAX.)

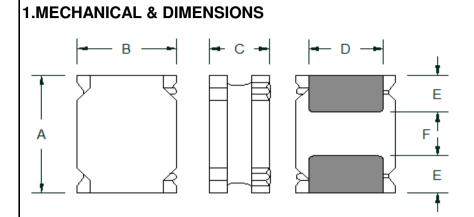
Note: Heat Rated Current (Irms) is tested on a typical PCB and apply a constant current in still air. The temperature rise is dependent on the application system condition including PCB PAD pattern, trace width and thickness and adjacent components etc. It's suggested to verify the temperature rise of the component under the real operation application conditions.

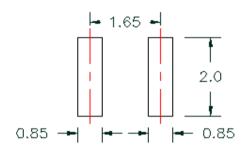


Shielded Power Inductor

www.laird.com TYS252010L Series Rev: A

SPECIFICATIOn





	(UNIT: mm)
Α	2.50±0.20
В	2.00±0.20
С	1.0+0.2/-0.3
D	1.50±0.20
Е	0.80±0.20
F	0.80±0.20
RE	MARK

2.PART NUMBER NOMENCLATOR:

A: Product Series.

B: Series number, part size

C: Inductance code

D: Inductance Tolerance. (M=±20%, N=±30%)

E: "X"=0:Standard catalog part number

"X"=1-9:Controlled customized part **Or** different performance than std catalog part.

3.EQUIVALENT CIRCUIT:





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			www.laird.co	m TYS2520	10L Series	Rev: A
SPECIFICAT	'IOn					
PART NUMBER	INDUCTANCE (uH)	Irms(A) Typ.	Isat(A) Typ.	DCR(mΩ) Max	SRF MHz	
ΓYS252010LR47N-10	0.47	2.35	2.50	56.0	202.0	
TYS252010LR68N-10	0.68	2.00	2.20	74.0	138.0	
ΓYS252010L1R0N-10	1.00	1.65	1.85	108.0	100.0	
TYS252010L1R5N-10	1.50	1.30	1.80	182.0	79.0	
ΓYS252010L2R2N-10	2.20	1.20	1.20	209.0	61.0	
YS252010L3R3M-10	3.30	0.90	1.05	328.0	48.0	
YS252010L4R7M-10	4.70	0.70	0.95	563.0	40.0	
ΓYS252010L6R8M-10	6.80	0.59	0.78	896.0	32.0	
ΓYS252010L100M-10	10.00	0.50	0.65	1092.0	26.0	
GENERAL SPECI	FICATION:					!
Tolerance: M: ±209	% or N: ±30%					
Inductance tested	at 100KHz, 0.25\	/rms				
Heat Rated Current	t (Irms) is define	d based on temp	perature rise app	roximate 40°C		
(ambient temperat	ture 25±5°C)					
Saturation Current	(Isat) is the DC	current at which	the inductance of	drops off approxi	mately 30%	
from its value with	out current. (am	bient temperatu	ıre 25±5°C)			
Operating tempera	nture range: -40°	C~+125°C (inclu	ding self-heating	temperature rise	e)	
Storage temperatu	re range (packag	ging conditions):	-10°C~+40°C and	d RH 70%(MAX.)		

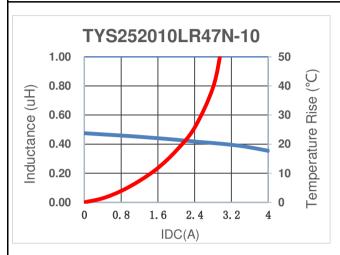


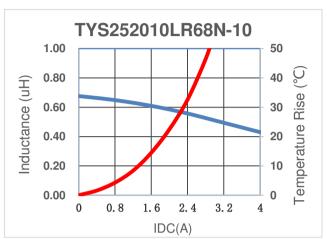
Shielded Power Inductor

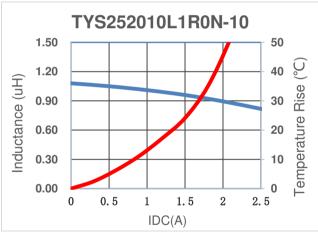
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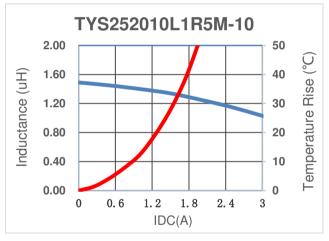
SPECIFICATION

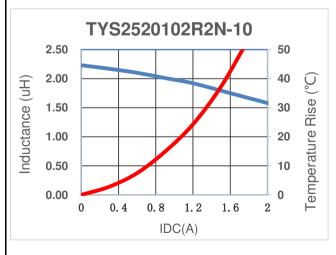
Characteristics Curve

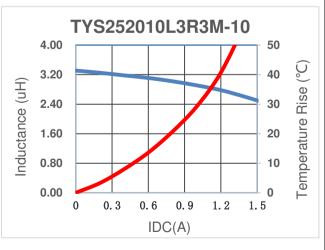












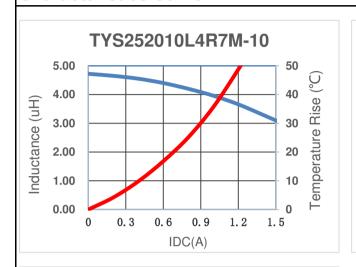


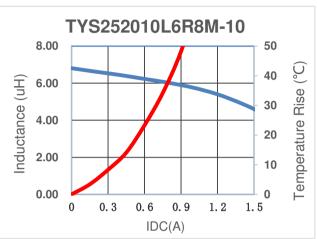
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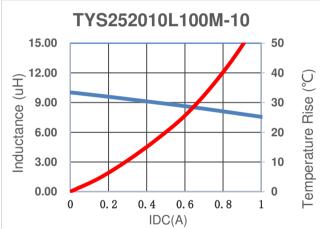
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SPECIFICATION

Characteristics Curve

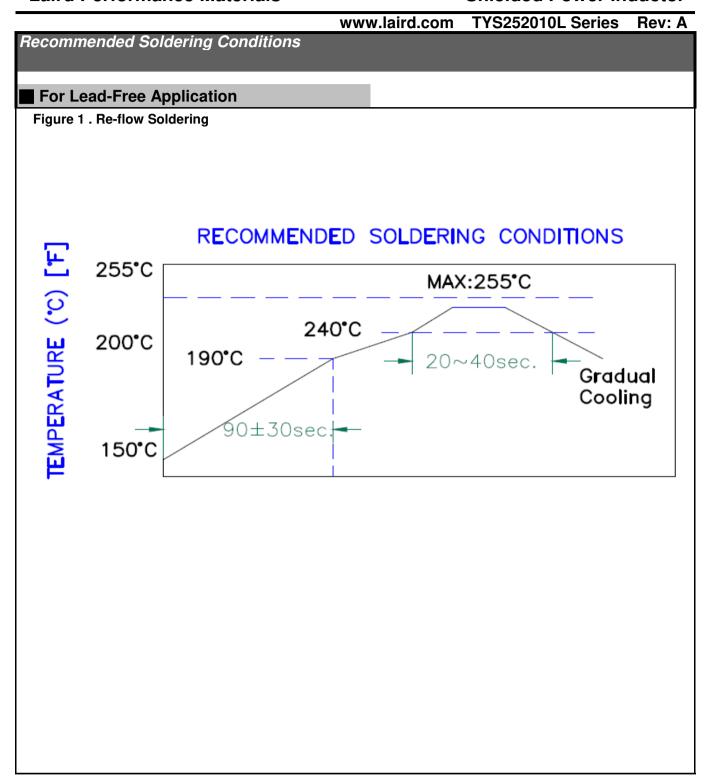








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Reliability and Testing Conditions / Pin Type Power Inductors

SMD series(Consumer)					
Item	Reference	Additional Requirements			
Operating temperature range	-40°C∼ +125°C (Including self-temperature rise)				
Storage temperature and humidity range	-10°ℂ to +40°ℂ,70% RH Max				
High Temperature Exposure (Storage)	MIL-STD-202 Method 108	85±2℃, 168+24hours			
Temperature Cycling	JESD22 Method JA-104	-40°C →+85, transforming interval:20s, 100cycles			
Operational Life	MIL-PRF-2	85±℃, 168+24hours Apply maximum rated voltage and current according part drawing			
External Visual	MIL-STD-883 Method 2009	Inspect device construction, marking and workmanship. Electrical Test not required.			
Physical Dimension	JESD22 Method JB-100	Verify physical dimensions to the applicable device detail specification. Note: User(s) and Suppliers spec. Electrical Test not required			
Vibration	MIL-STD-202 Method 204	10~55Hz,1.5mm, 2 hours in each 3mutually perpendicular directions (total of 6 hours)			
Resistance to Soldering Heat	MIL-STD-202 Method 210	1. Max. 260±5°C,10±1s, 2 times 2.Solder Composition: Sn/3Ag/0.5Cu			
Solderability	J-STD-002	245±5℃, 5±1sec, Solder: Sn/3.0Ag/0.5Cu			
Electrical Characterization	Print Spec	Parametrically test per lot and sample size requirements, summary to show Min, Max, Mean and Standard deviation at room as well as Min and Max Operating temperatures			
Board Flex	AEC-Q200-005	2mm,30±1s			
Terminal Strength(SMD)	AEC-Q200-006	10N, 5S, X,Y direct			

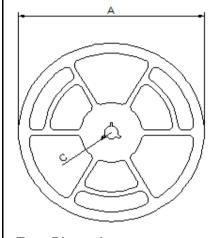


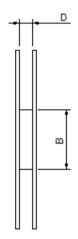
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PACKAGING

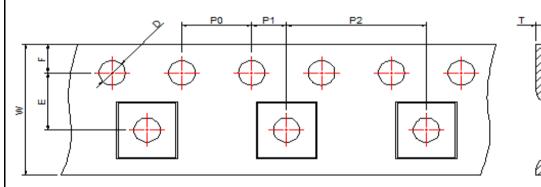
Reel Dimension





A(mm)	180
B(mm)	60
C(mm)	13
D(mm)	9.2

Tape Dimension

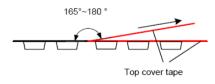


W	Е	F	P0	P1	P2	Т	D
8.0±0.3	3.5±0.1	1.75±0.1	4.0±0.1	2.0±0.1	4.0±0.1	0.3±0.05	1.5±0.1

Packaging Quantity

	•		
P/N	Chip/Reel	Inner Box	Outer Box
TYS252010L series	2000pcs	10000	50000

Peeling Off Force



The force peeling off cove tape is 10 to 100 grams					
in the arrow direction under the following conditions					
Room	Room Humidity	Room atrn	Teaming Speed		
Temp	(%)	(hPa)	(mm/min)		
5~35	45~85	860~1060	300		

- **XStorage Conditions**

 1. Temperature and humidity conditions: -10-+40[°]C and 70[°]C RH.
- 2. Recommended products should be used within 12 months from the time of manufacturing.
- The packaging material should be kept where no chlorine or sulfur exists in the air.
- 4. Allowable stacking condition of Packaging box: max height 1.5m or 5 boxes stacking